Product Information

Ultramid[®] A3WG6 Polyamide 66



Product Description

Ultramid A3WG6 is a 30% glass fiber reinforced and heat resistance injection molding PA66 grade for machinery components and housings of high stiffness and dimensional stability.

Applications

Typical applications include lamp socket housings, cooling fans, insulating profiles for aluminum window frames, water containers for automotive cooling systems.

PHYSICAL	ASTM Test Method	Droporty	Valua
	D-792	Property Value	
Specific Gravity	D-792	0.003	
Mold Shrinkage (1/8" bar, in/in)	D-570	0.003	
Moisture, %	D-570	1.7	
(50% RH)			
(Saturation)		5.5	
	ASTM Test Method	Dry	Conditioned
Tensile Strength, Break, MPa (psi)	D-638	(00 (07 000)	
23C (73F)		186 (27,000)	-
Elongation, Break, %	D-638	-	
23C (73F)		3	-
Flexural Modulus, MPa (psi)	D-790		
23C (73F)		8,480 (1,230,000)	-
IMPACT	ASTM Test Method	Dry	Conditioned
Notched Izod Impact, J/M (ft-lbs/in)	D-256		
-40C (-40F)		91 (1.7)	-
23C (73F)		112 (2.1)	-
THERMAL	ASTM Test Method	Dry	Conditioned
Melting Point, C(F)	D-3418	260 (500)	-
Heat Deflection @ 264 psi (1.8 MPa) C(F)	D-648	250 (482)	-
Heat Deflection @ 66 psi (.45 MPa) C(F)	D-648	250 (482)	-
Coef. of Linear Thermal Expansion, mm/mm C (in/in F)	E-831	0.1 X10-4	-
UL RATINGS	UL Test Method	Property Value	
Flammability Rating, 1.5mm	UL94	HB	
Relative Temperature Index, 1.5mm	UL746B		
Mechanical w/o Impact, C		115	
Mechanical w/ Impact, C		115	
Electrical, C		125	
ELECTRICAL	ASTM Test Method	Dry	Conditioned
Volume Resistivity, 1.5 mm	D-257	1E13	1E10

Processing Guidelines

Material Handling Max. Water content: 0.12%





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Product is supplied in sealed containers and drying prior to molding is not required. If drying becomes necessary, a dehumidifying or desiccant dryer operating at 80 degC (176 degF) is recommended. Drying time is dependent on moisture level, but 2-4 hours is generally sufficient. Further information concerning safe handling procedures can be obtained from the Material Safety Data Sheet. Alternatively, please contact your BASF representative.

Typical Profile

Melt Temperature 280-305 degC (536-581 degF) Mold Temperature 80-90 degC (176-194 degF) Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures

A mold temperature of 80-90 degC (176-194 degF) is recommended, but temperatures of as low as 45 degC (113 degF) and as high as 105 degC (221 degF) can be used where applicable.

Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. Minimal back pressure should be utilized to prevent glass breakage.

Fill Rate

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.



